


NOTES:
 1.MATERIAL:
 HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL 94V-0
 LCP E130I,BLACK
 CAP: HIGH TEMPERATURE THERMOPLASTIC UL 94V-0
 LCP RE-GRINDING,BLACK
 TERMINAL: COPPER ALLOY C5210,T=0.25MM
 FORKLOCK: COPPER ALLOY C2680,T=0.30MM
 2.FINISHED:
 CONTACT: GOLD PLATING ONCONTACT AREA,MATTE TIN
 PLATING ON SOLDER TAIL AREA,NICKEL UNDER
 3.COPLANARITY: 0.10MM MAX

REV.	REVISION RECORD	DATE	UNIT: MM	GENERAL TOLERANCES		SCALE 1:1	NAME	DATE	PART NO.	DWG NO.	 TERMINAL&CONNECTORS		
A	INITIAL RELEASED	2020.07.22		LINEAR	ANGLES	APPROVED	Daniel. Dong	2024.05.31	80802W00-2X68PA-SF-005	ENDE05			
B	ADD DIMENSION	2020.07.22	0.00±0.30	X° REF±5°	DESIGNER	Jackie Tan	2024.05.31	TITLE					
C	ADD THE SKIMMING HOLE	2024.05.31	0.00±0.25	X° ±2°	DRAWN	Girder.Liang	2024.05.31	PCIE/SAS VERTICAL SMT REC-SHORT LEGS+FORKLOCK SMT TYPE					
			SIZE: A4	0.000±0.05	X° ±2°					REV	C	SHEET	1/1